TES PATENT AND TRADEMARK OFFICE

Applicant:

S/N 10/774,923

Qing Ma

Examiner: Roy K. Potter

Serial No.:

10/774,923

Group Art Unit: 2822

Filed:

February 9, 2004

Docket: 884.803US2

Title:

DIRECT BUILD-UP LAYER ON AN ENCAPSULATED DIE PACKAGE

HAVING A MOISTURE BARRIER STRUCTURE

Assignee:

Intel Corporation

Customer No. 21186

NOTICE OF APPEAL FROM THE DECISION OF THE EXAMINER TO THE BOARD OF PATENT APPEALS AND INTERFERENCES

MAIL STOP AF

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with 37 C.F.R. § 41.31(a)(1), Applicant hereby appeals to the Board of Patent Appeals and Interferences from the decision dated October 6, 2005, of the Examiner rejecting claims 20 and 29 of the above-identified patent application.

A Pre-Appeal Brief Request for Review is submitted herewith.

A request for an extension of time to respond to the Examiner's rejection is submitted herewith along with payment of the required extension fee.

Please charge the amount of \$500.00 in payment of the Notice of Appeal fee under 37 C.F.R. § 41.20(b)(1), as well as any additional required fees, to Deposit Account No. 19-0743.

Respectfully submitted,

OING MA

By her Attorneys,

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop AF, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 6th day of February, 2006.

Chris Hammond

Name

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